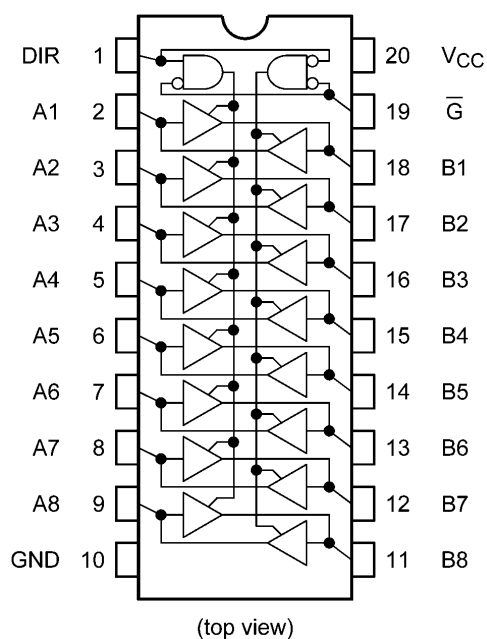
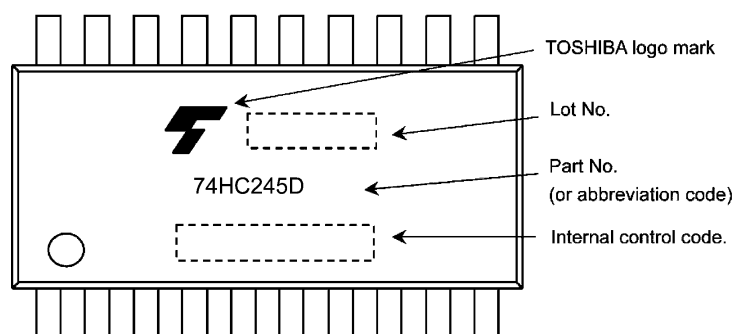


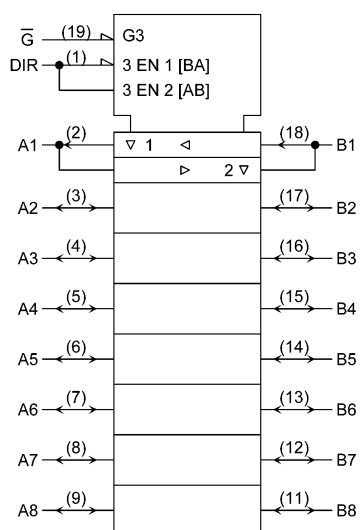
5. Pin Assignment



6. Marking



7. IEC Logic Symbol



8. Truth Table

Input $\overline{G}$	Input DIR	A BUS	B BUS	Output
L	L	Output	Input	A = B
L	H	Input	Output	B = A
H	X	Z	Z	Z

X: Don't care (L or H)

Z: High impedance

9. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V_{CC}		-0.5 to 7.0	V
Input voltage	V_{IN}		-0.5 to $V_{CC} + 0.5$	V
Output voltage	V_{OUT}		-0.5 to $V_{CC} + 0.5$	V
Input diode current	I_{IK}		± 20	mA
Output diode current	I_{OK}		± 20	mA
Output current	I_{OUT}		± 35	mA
V_{CC} /ground current	I_{CC}		± 75	mA
Power dissipation	P_D	(Note 1)	500	mW
Storage temperature	T_{stg}		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: P_D derates linearly with -8 mW/°C above 85 °C

10. Operating Ranges (Note)

Characteristics	Symbol	Test Condition	Rating	Unit
Supply voltage	V_{CC}	—	2.0 to 6.0	V
Input voltage	V_{IN}	—	0 to V_{CC}	V
Output voltage	V_{OUT}	—	0 to V_{CC}	V
Operating temperature	T_{opr}	—	-40 to 125	°C
Input rise and fall times	t_r, t_f	—	0 to 50	μs

Note: The operating ranges are required to ensure the normal operation of the device. Unused inputs and bus inputs must be tied to either V_{CC} or GND. Please connect both bus inputs and the bus outputs with V_{CC} or GND when the I/O of the bus terminal changes by the function. In this case, please note that the output is not short-circuited.

11. Electrical Characteristics

11.1. DC Characteristics (Unless otherwise specified, $T_a = 25\text{ }^{\circ}\text{C}$)

Characteristics	Symbol	Test Condition		V_{CC} (V)	Min	Typ.	Max	Unit
High-level input voltage	V_{IH}	—		2.0	1.50	—	—	V
				4.5	3.15	—	—	
				6.0	4.20	—	—	
Low-level input voltage	V_{IL}	—		2.0	—	—	0.50	V
				4.5	—	—	1.35	
				6.0	—	—	1.80	
High-level output voltage	V_{OH}	$V_{IN} = V_{IH} \text{ or } V_{IL}$	$I_{OH} = -20\text{ }\mu\text{A}$	2.0	1.9	2.0	—	V
				4.5	4.4	4.5	—	
				6.0	5.9	6.0	—	
			$I_{OH} = -6\text{ mA}$	4.5	4.18	4.31	—	
			$I_{OH} = -7.8\text{ mA}$	6.0	5.68	5.80	—	
Low-level output voltage	V_{OL}	$V_{IN} = V_{IH} \text{ or } V_{IL}$	$I_{OL} = 20\text{ }\mu\text{A}$	2.0	—	0.0	0.1	V
				4.5	—	0.0	0.1	
				6.0	—	0.0	0.1	
			$I_{OL} = 6\text{ mA}$	4.5	—	0.17	0.26	
			$I_{OL} = 7.8\text{ mA}$	6.0	—	0.18	0.26	
3-state output OFF-state leakage current	I_{OZ}	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or } GND$		6.0	—	—	± 0.5	μA
Input leakage current	I_{IN}	$V_{IN} = V_{CC} \text{ or } GND$		6.0	—	—	± 0.1	μA
Quiescent supply current	I_{CC}	$V_{IN} = V_{CC} \text{ or } GND$		6.0	—	—	4.0	μA

11.2. DC Characteristics (Unless otherwise specified, $T_a = -40 \text{ to } 85\text{ }^{\circ}\text{C}$)

Characteristics	Symbol	Test Condition		V_{CC} (V)	Min	Max	Unit
High-level input voltage	V_{IH}	—		2.0	1.50	—	V
				4.5	3.15	—	
				6.0	4.20	—	
Low-level input voltage	V_{IL}	—		2.0	—	0.50	V
				4.5	—	1.35	
				6.0	—	1.80	
High-level output voltage	V_{OH}	$V_{IN} = V_{IH} \text{ or } V_{IL}$	$I_{OH} = -20\text{ }\mu\text{A}$	2.0	1.9	—	V
				4.5	4.4	—	
				6.0	5.9	—	
			$I_{OH} = -6\text{ mA}$	4.5	4.13	—	
			$I_{OH} = -7.8\text{ mA}$	6.0	5.63	—	
Low-level output voltage	V_{OL}	$V_{IN} = V_{IH} \text{ or } V_{IL}$	$I_{OL} = 20\text{ }\mu\text{A}$	2.0	—	0.1	V
				4.5	—	0.1	
				6.0	—	0.1	
			$I_{OL} = 6\text{ mA}$	4.5	—	0.33	
			$I_{OL} = 7.8\text{ mA}$	6.0	—	0.33	
3-state output OFF-state leakage current	I_{OZ}	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or } GND$		6.0	—	± 5.0	μA
Input leakage current	I_{IN}	$V_{IN} = V_{CC} \text{ or } GND$		6.0	—	± 1.0	μA
Quiescent supply current	I_{CC}	$V_{IN} = V_{CC} \text{ or } GND$		6.0	—	40.0	μA

11.3. DC Characteristics (Unless otherwise specified, $T_a = -40$ to $125\text{ }^\circ\text{C}$)

Characteristics	Symbol	Test Condition		V_{CC} (V)	Min	Max	Unit
High-level input voltage	V_{IH}	—		2.0	1.50	—	V
				4.5	3.15	—	
				6.0	4.20	—	
Low-level input voltage	V_{IL}	—		2.0	—	0.50	V
				4.5	—	1.35	
				6.0	—	1.80	
High-level output voltage	V_{OH}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OH} = -20\text{ }\mu\text{A}$	2.0	1.9	—	V
				4.5	4.4	—	
				6.0	5.9	—	
			$I_{OH} = -6\text{ mA}$	4.5	3.7	—	
			$I_{OH} = -7.8\text{ mA}$	6.0	5.2	—	
Low-level output voltage	V_{OL}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OL} = 20\text{ }\mu\text{A}$	2.0	—	0.1	V
				4.5	—	0.1	
				6.0	—	0.1	
			$I_{OL} = 6\text{ mA}$	4.5	—	0.4	
			$I_{OL} = 7.8\text{ mA}$	6.0	—	0.4	
3-state output OFF-state leakage current	I_{OZ}	$V_{IN} = V_{IH}$ or V_{IL} $V_{OUT} = V_{CC}$ or GND		6.0	—	± 10.0	μA
Input leakage current	I_{IN}	$V_{IN} = V_{CC}$ or GND		6.0	—	± 1.0	μA
Quiescent supply current	I_{CC}	$V_{IN} = V_{CC}$ or GND		6.0	—	160.0	μA

11.4. AC Characteristics (Unless otherwise specified, $T_a = 25\text{ }^\circ\text{C}$, Input: $t_r = t_f = 6\text{ ns}$)

Characteristics	Symbol	Note	Test Condition	C _L (pF)	V _{CC} (V)	Min	Typ.	Max	Unit
Output transition time	t _{TLH} , t _{THL}		—	50	2.0	—	52	60	ns
					4.5	—	7	12	
					6.0	—	6	10	
Propagation delay time	t _{PLH} , t _{PHL}		—	50	2.0	—	33	90	ns
					4.5	—	12	18	
					6.0	—	10	15	
				150	2.0	—	48	120	
					4.5	—	16	24	
					6.0	—	14	20	
3-state output enable time	t _{PZL} , t _{PZH}		R _L = 1 kΩ	50	2.0	—	48	150	ns
					4.5	—	16	30	
					6.0	—	14	26	
				150	2.0	—	63	180	
					4.5	—	21	36	
					6.0	—	18	31	
3-state output disable time	t _{PLZ} , t _{PHZ}		R _L = 1 kΩ	50	2.0	—	37	150	ns
					4.5	—	17	30	
					6.0	—	15	26	
Input capacitance	C _{IN}		DIR, $\overline{G}$			—	3	—	pF
Power dissipation capacitance	C _{PD}	(Note 1)	—			—	12	—	pF

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.

$$I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/8 \text{ (per bit)}$$

11.5. AC Characteristics

(Unless otherwise specified, $T_a = -40$ to $85\text{ }^\circ\text{C}$, Input: $t_r = t_f = 6\text{ ns}$)

Characteristics	Symbol	Test Condition	C_L (pF)	V_{CC} (V)	Min	Max	Unit
Output transition time	t_{TLH}, t_{THL}	—	50	2.0	—	75	ns
				4.5	—	15	
				6.0	—	13	
Propagation delay time	t_{PLH}, t_{PHL}	—	50	2.0	—	115	ns
				4.5	—	23	
				6.0	—	20	
			150	2.0	—	150	
				4.5	—	30	
				6.0	—	26	
3-state output enable time	t_{PZL}, t_{PZH}	$R_L = 1\text{ k}\Omega$	50	2.0	—	190	ns
				4.5	—	38	
				6.0	—	32	
			150	2.0	—	225	
				4.5	—	45	
				6.0	—	38	
3-state output disable time	t_{PLZ}, t_{PHZ}	$R_L = 1\text{ k}\Omega$	50	2.0	—	190	ns
				4.5	—	38	
				6.0	—	32	

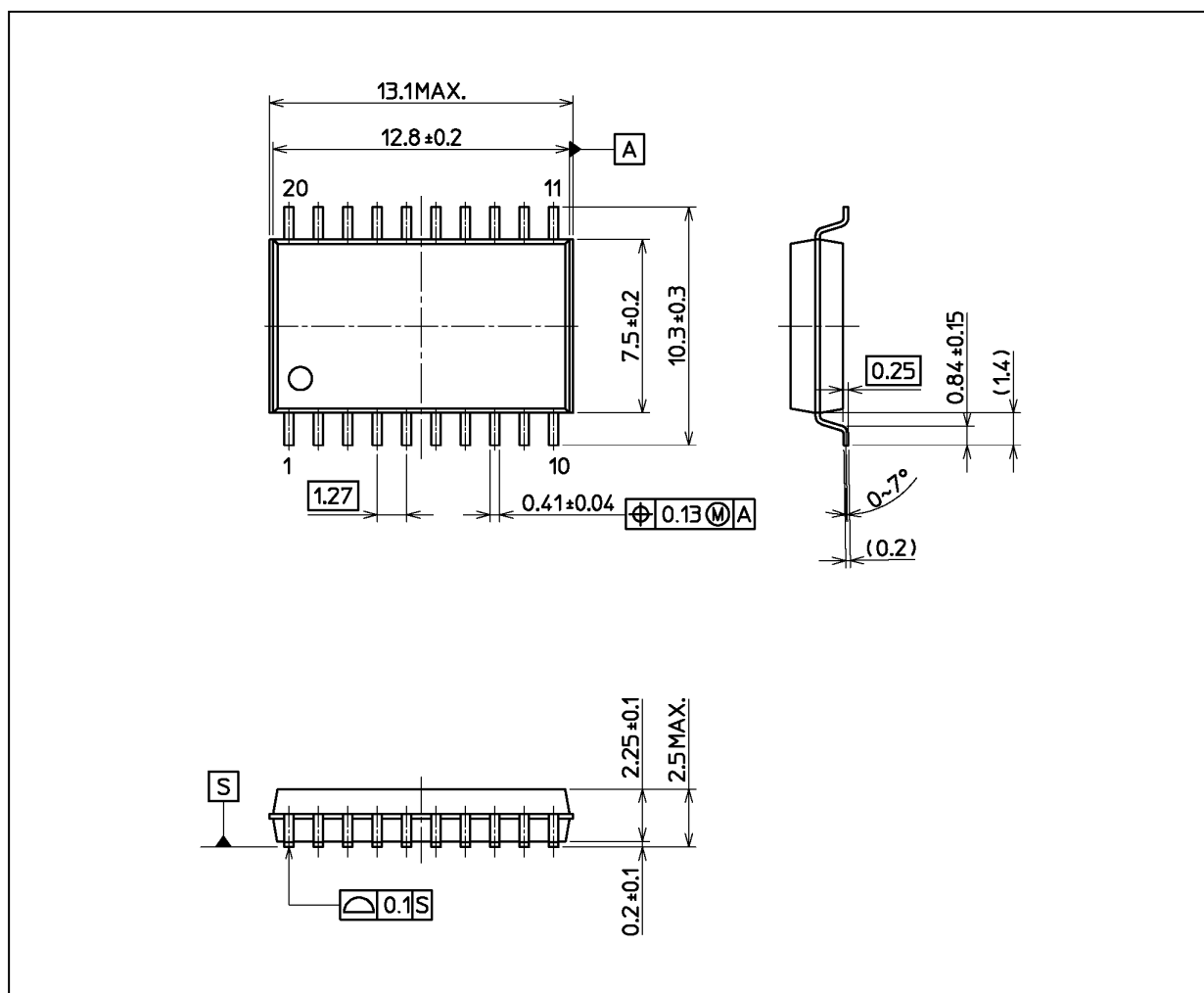
11.6. AC Characteristics

(Unless otherwise specified, $T_a = -40$ to $125\text{ }^\circ\text{C}$, Input: $t_r = t_f = 6\text{ ns}$)

Characteristics	Symbol	Test Condition	C_L (pF)	V_{CC} (V)	Min	Max	Unit
Output transition time	t_{TLH}, t_{THL}	—	50	2.0	—	90	ns
				4.5	—	18	
				6.0	—	15	
Propagation delay time	t_{PLH}, t_{PHL}	—	50	2.0	—	135	ns
				4.5	—	27	
				6.0	—	23	
			150	2.0	—	180	
				4.5	—	36	
				6.0	—	31	
3-state output enable time	t_{PZL}, t_{PZH}	$R_L = 1\text{ k}\Omega$	50	2.0	—	225	ns
				4.5	—	45	
				6.0	—	38	
			150	2.0	—	270	
				4.5	—	54	
				6.0	—	46	
3-state output disable time	t_{PLZ}, t_{PHZ}	$R_L = 1\text{ k}\Omega$	50	2.0	—	225	ns
				4.5	—	45	
				6.0	—	38	

Package Dimensions

Unit: mm



Weight: 0.51 g (typ.)

Package Name(s)
Nickname: SOIC20

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